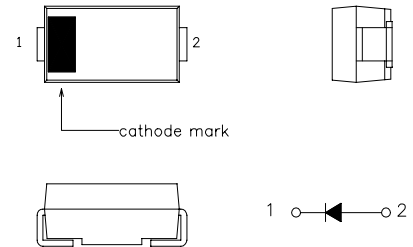


SBD Type : EC10QS04

FEATURES

- * Miniature Size, Surface Mount Device
- * Low Forward Voltage Drop
- * Low Power Loss, High Efficiency
- * High Surge Capability
- * 30 Volts through 100Volts Types Available
- * Packaged in 12mm Tape and Reel
- * Not Rolling During Assembly

OUTLINE DRAWING



Maximum Ratings

Approx Net Weight: 0.06g

Rating	Symbol	EC10QS04			Unit
Repetitive Peak Reverse Voltage	V _{RRM}	40			V
Non-repetitive Peak Reverse Voltage	V _{RSM}	45			
Average Rectified Output Current	I _O	0.91	Ta=28 °C *1	50Hz Half Sine Wave Resistive Load	A
		1.0	Ta=53 °C *2		
RMS Forward Current	I _{F(RMS)}	1.57			A
Surge Forward Current	I _{FSM}	20	50Hz Half Sine Wave,1cycle Non-repetitive		A
Operating JunctionTemperature Range	T _{jw}	-40 to +150			°C
Storage Temperature Range	T _{stg}	-40 to +150			°C

Electrical • Thermal Characteristics

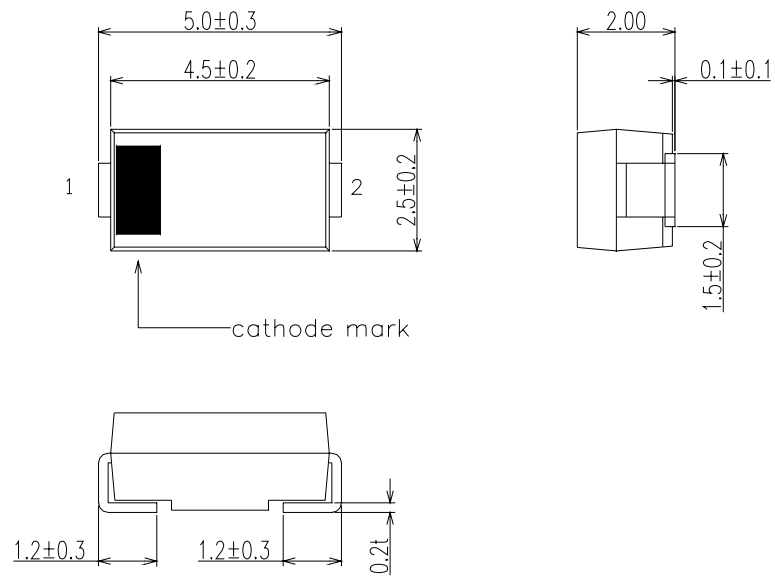
Characteristics	Symbol	Conditions		Min.	Typ.	Max.	Unit
Peak Reverse Current	I _{RM}	Tj= 25°C, V _{RM} = V _{RRM}		-	-	1.0	mA
Peak Forward Voltage	V _{FM}	Tj= 25°C, I _{FM} = 1.0A		-	-	0.55	V
Thermal Resistance	Rth(j-a)	Junction to Ambient	*1	-	-	157	°C /W
			*2	-	-	108	

*1 Glass Epoxy Substrate Mounted

*2 Alumina Substrate Mounted

Soldering Lands = 2x2mm, Both Sides

EC10QS04 OUTLINE DRAWING (Dimensions in mm)



SOLDERING PAD

